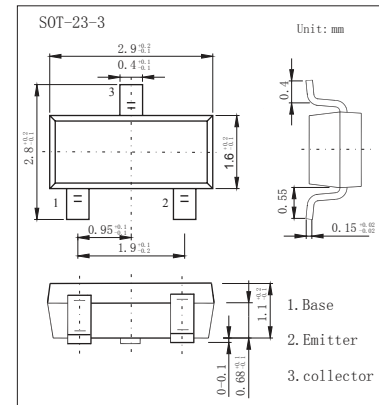


PNP Medium Power Transistor

ZXTP19100CFF

■ Features

- $BV_{CEO} > -100V$
- $BV_{ECO} > -7V$
- $I_C = -2A$ Continuous Collector Current
- Saturation Voltage $V_{CE(SAT)} < -120mV @ -1A$
- h_{FE} Characterised Up to $-2A$
- $R_{CE(SAT)} = 95m\Omega$
- 1.5W Power Dissipation
- Complementary NPN Type: ZXTN19100CFF

■ Absolute Maximum Ratings (@ $T_A = +25^\circ C$, unless otherwise specified.)

Parameter	Symbol	Rating	Unit	
Collector - Base Voltage	V_{CBO}	-110	V	
Collector-Emitter Voltage (Forward blocking)	V_{CEX}	-110		
Collector - Emitter Voltage	V_{CEO}	-100		
Emitter-Collector Voltage (Reverse blocking)	V_{ECO}	-7		
Emitter - Base Voltage	V_{EBO}	-7		
Collector Current - Continuous	I_C	-2	A	
Peak Pulse Current	I_{CM}	-3		
Base Current	I_B	-1		
Power Dissipation Linear Derating Factor	(Note 1)	0.84 6.72	W mW/ $^\circ C$	
	(Note 2)	1.34 10.72		
	(Note 3)	1.50 12.0		
	(Note 4)	2.0 16.0		
Thermal Resistance Junction to Ambient	(Note 1)	149	$^\circ C/W$	
	(Note 2)	93		
	(Note 3)	83		
	(Note 4)	60		
Thermal Resistance, Junction to Lead	(Note 5)	$R_{\theta JL}$	43.8	
Junction Temperature	T_J	150	$^\circ C$	
Storage Temperature range	T_{stg}	-55 to 150		

■ ESD Ratings (Note 6)

Parameter	JEDEC Class	Symbol	Rating	Unit
Electrostatic Discharge – Human Body Model	3A	ESD HBM	4,000	V
Electrostatic Discharge – Machine Model	C	ESD MM	400	

Notes: 1. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

2. Same as Note 1, except the device is mounted on 25mm x 25mm 2oz copper.
3. Same as Note 1, except the device is mounted on 50mm x 50mm 2oz copper.
4. Same as Note 3, whilst measured at $t < 5$ seconds.
5. Thermal resistance from junction to solder-point (at the end of the collector lead).
6. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

PNP Medium Power Transistor

ZXTP19100CFF

■ Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector-Base Breakdown Voltage	BV_{CBO}	$I_C = -100\ \mu\text{A}$	-110			V
Collector-Emitter Breakdown Voltage (Base Open)	BV_{CEX}	$I_C = -100\ \mu\text{A}$, $R_{BC} < 1\ \text{k}\Omega$ or $0.25\text{V} > V_{BC} > -0.25\text{V}$	-110			
Collector-Emitter Breakdown Voltage (Base Open) (Note 7)	BV_{CEO}	$I_C = -10\ \text{mA}$	-100			
Emitter-Base Breakdown Voltage	BV_{EBO}	$I_E = -100\ \mu\text{A}$	-7			
Emitter-Collector Breakdown Voltage	BV_{ECX}	$I_E = -100\ \mu\text{A}$, $R_{BC} < 1\ \text{k}\Omega$ or $0.25\text{V} > V_{BC} > -0.25\text{V}$	-7			
Emitter-Collector Breakdown Voltage (Base Open)	BV_{ECO}	$I_E = -100\ \mu\text{A}$	-7			
Collector-Base Cutoff Current	I_{CBO}	$V_{CB} = -110\text{V}$			-50	nA
		$V_{CB} = -110\text{V}$, $T_A = +100^\circ\text{C}$			-0.5	μA
Emitter-Base Cutoff Current	I_{EBO}	$V_{EB} = -5.6\text{V}$			-50	nA
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = -0.5\text{A}$, $I_B = -20\text{mA}$			-130	mV
		$I_C = -1\text{A}$, $I_B = -100\text{mA}$			-120	
		$I_C = -1\text{A}$, $I_B = -50\text{mA}$			-225	
		$I_C = -2\text{A}$, $I_B = -200\text{mA}$			-275	
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C = -2\text{A}$, $I_B = -200\text{mA}$			-950	
Base-Emitter On Voltage	$V_{BE(ON)}$	$I_C = -2\text{A}$, $V_{CE} = -2\text{V}$			-900	
Static Forward Current Transfer Ratio	h_{FE}	$I_C = -100\text{mA}$, $V_{CE} = -2\text{V}$	200		500	
		$I_C = -1\text{A}$, $V_{CE} = -2\text{V}$	70			
		$I_C = -2\text{A}$, $V_{CE} = -2\text{V}$	20			
Input Capacitance	C_{iBO}	$V_{EB} = -0.5\text{V}$, $f = 1\text{MHz}$		291	400	pF
Output Capacitance	C_{oBO}	$V_{CB} = -1\text{V}$, $f = 1\text{MHz}$		23.5		
Delay Time	t_d	$V_{CC} = -10\text{V}$, $I_C = -0.5\text{A}$, $I_{B1} = -I_{B2} = -50\text{mA}$		24.7		ns
Rise Time	t_r			22.4		
Storage Time	t_s			660		
Fall Time	t_f			107		
Transition Frequency	f_T	$I_C = -100\text{mA}$, $V_{CE} = -10\text{V}$, $f = 50\text{MHz}$		142		MHz

Note 7. Measured under pulsed conditions. Pulse width $\leq 300\ \mu\text{s}$. Duty cycle $\leq 2\%$.

■ Marking

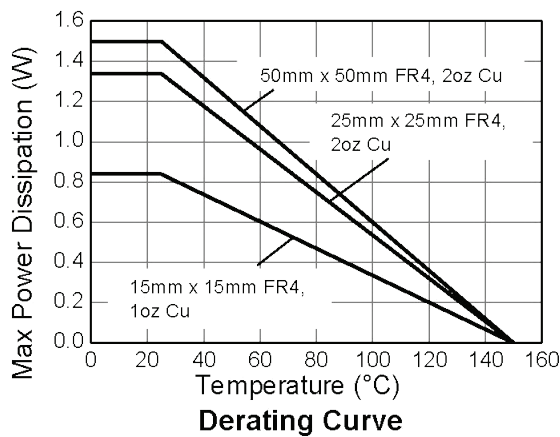
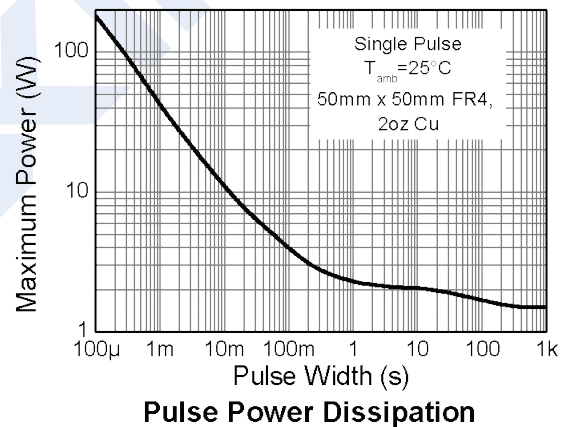
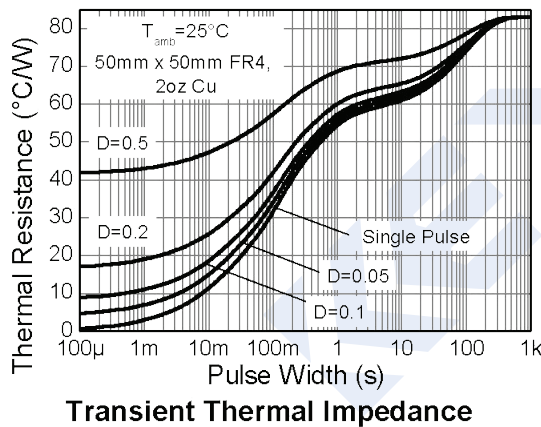
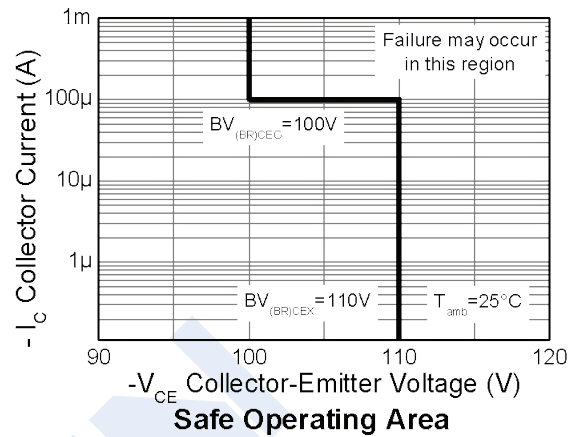
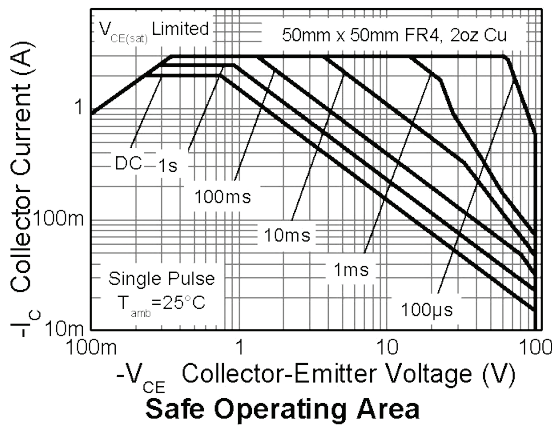
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PNP Medium Power Transistor

ZXTP19100CFF

■ Thermal Characteristics and Derating Information



PNP Medium Power Transistor

ZXTP19100CFF

■ Typical Characteristics

